Abstract

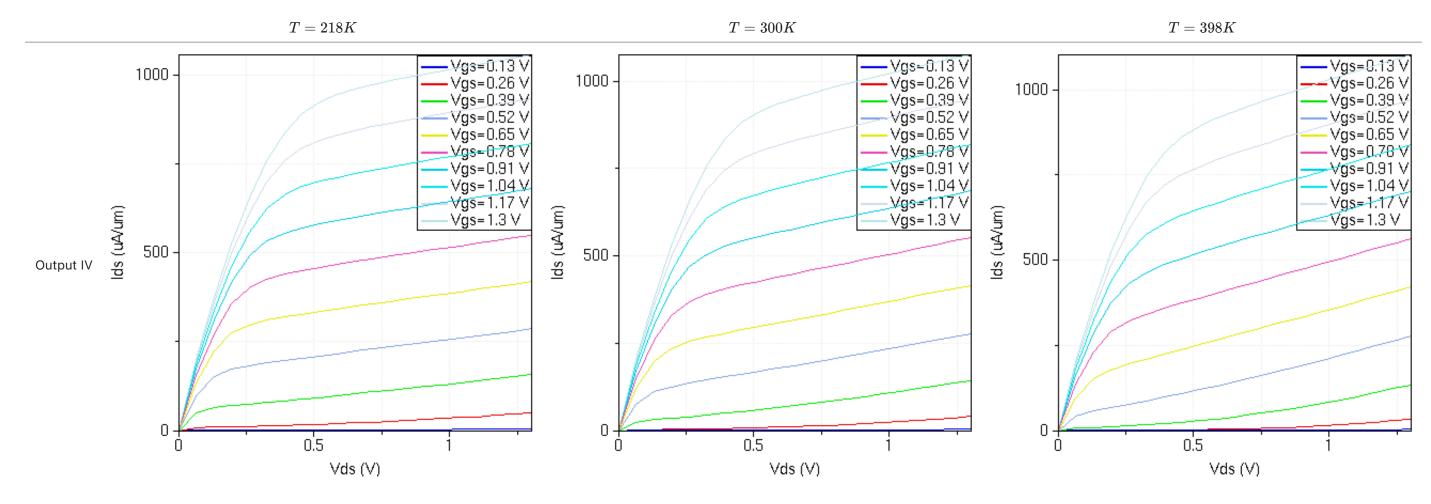
This compact model MOSFET IV simulation work pertains to 130nm and 45nm CMOS technology nodes, using nanoHUB's 'Nano-CMOS' tool.

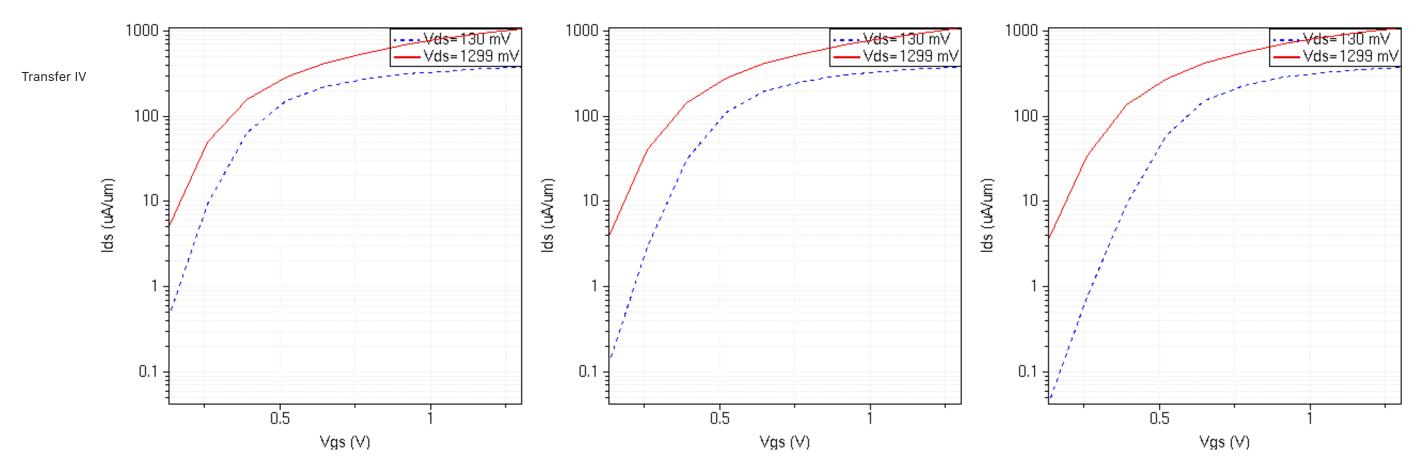
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Part I: 130nm NMOS Output and Transfer IV

Simulations at $T=\min, nominal \& max$





Summary

1. I_d vs $V_d \forall V_a$ plots of 130nm NMOS transistor can be seen to follow the generic MOSFET IV trend:

$$I_d = \frac{W}{L} \cdot C_{oxe} \cdot \mu \cdot (V_g - V_T - \frac{1}{2}V_d) \cdot V_d \tag{1}$$

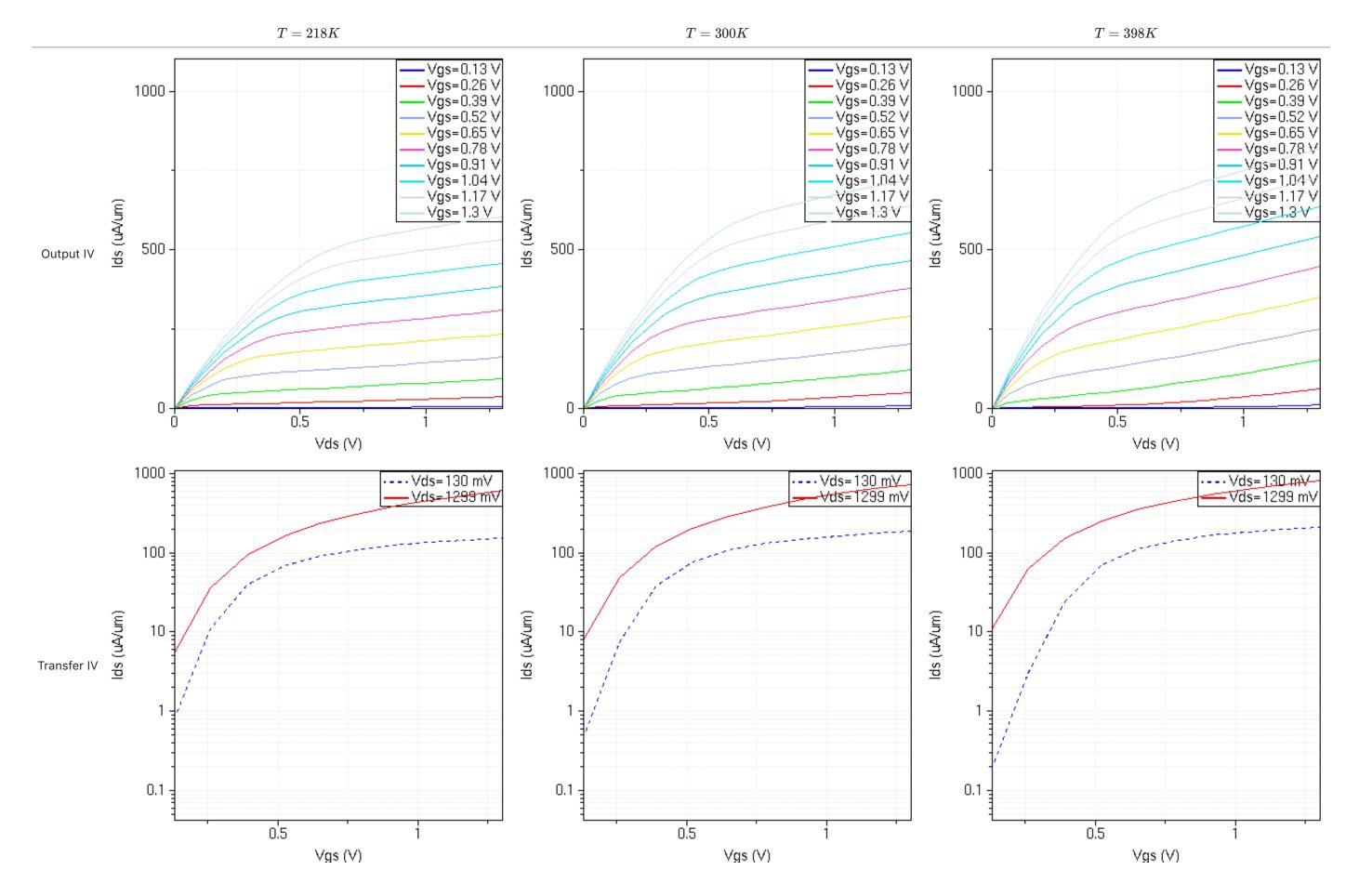
2. $\log I_d$ vs $V_g \forall V_d$ plots of 130nm NMOS transistor indicate the linear subthreshold region leading up to the first curvature transition point (V_T) . This linear region can be represented by the following equation:

$$I_d = 100 \cdot rac{W}{L} \cdot 10^{rac{q(V_g - V_T)}{\eta kT}} = 100 \cdot rac{W}{L} \cdot 10^{rac{(V_g - V_T)}{S}}$$
 (2)

3. From the above plots it can be observed that the effect of increasing T leads to a corresponding lowering of V_T , and hence following from Eq. (1) \& Eq. (2) it can also be observed to lead to a higher I_d in the above plots.

Part II: 130nm PMOS Output and Transfer IV

Simulations at $T=\min, nominal \& max$



Summary

- 1. I_d vs $V_d \forall V_q$ plots of 130nm PMOS transistor can be seen to follow the same generic MOSFET IV trend as Eq. (1) (with a lower μ than NMOS).
- 2. $\log I_d$ vs $V_g \forall V_d$ plots of 130nm PMOS transistor indicate the linear subthreshold region leading up to the first curvature transition point (V_T) . This linear region can be represented by an equation similar to Eq. (2).
- 3. From the above plots it can be observed that the effect of increasing T leads to a corresponding lowering of V_T , and hence following from Eq. (1) \& Eq. (2) it can also be observed to lead to a higher I_d in the above plots.
- 4. Except in 130nm PMOS plots the effect of increasing I_d (or lowering V_T) with increasing T is more pronounced than 130nm NMOS. And this is due to lower channel length modulation effect $(1/\lambda)$ in PMOS transistors than in NMOS transistors.

Part III: 130nm NMOS model parameter extraction

Calculation of T Parameters for V_{th} (all units appropriated from nanoHUB's 'Nano-CMOS' compact model)

$$V_{\rm th}(T) = V_{\rm th}({\rm TNOM}) + \left({\rm KT1} + \frac{{\rm KT1L}}{L_{\rm eff}} + {\rm KT2} \cdot V_{\rm bs,eff}\right) \cdot \left(\frac{T}{\rm TNOM} - 1\right) \tag{3}$$

(as noted in page 105 of [2] BSIM 4.8.2 Technical Manual)

where,

$$V_{
m bs,eff} = V_{
m bc} + 0.5 \cdot \left[\left(V_{
m bs} - V_{
m bc} - 0.001 \right) + \sqrt{ \left(V_{
m bs} - V_{
m bc} - 0.001 \right)^2 - 4 \cdot 0.001 \cdot V_{
m bc}} \right]$$
 (4)

(as noted in page 2-11 of [3] BSIM 4.3.0 Technical Manual)

where,

$$V_{
m bc} = 0.9 \cdot \left(\Phi_s - rac{ ext{K}1^2}{4 \cdot ext{K}2^2}
ight)$$
 (5)

(as noted in page 2-11 of [3] BSIM 4.3.0 Technical Manual)

where,

$$\Phi_s = 0.4 + \frac{k_B \cdot T}{q} \ln \left(\frac{\text{NDEP}}{n_i} \right) + \text{PHIN}$$
(6)

(as noted in Note-2 of Appendix A-31 of [3] BSIM 4.3.0 Technical Manual)

where,

$$n_i = 1.45e10 \cdot \left(\frac{\mathrm{T}}{300.15}\right)^{3/2} \cdot \exp\left(\left[21.5565981 - \frac{q \cdot E_g(T)}{2 \cdot k_B \cdot T}\right]\right) \tag{7}$$

(as noted in page 112 of [2] BSIM 4.8.2 Technical Manual)

where,

$$E_g(T) = 1.16 - \frac{7.02 \times 10^{-4} \times T^2}{T + 1108} \tag{8}$$

(as noted in page 112 of [2] BSIM 4.8.2 Technical Manual)

where,

$$TNOM = 300, PHIN = 0, L_{eff} = 49, V_{bs} = 0$$
 (9)

(which are defaults of the Nano-CMOS compact model)

Table summarising T parameter extracts from Nano-CMOS compact model relating to V_{th}

$T\left(K\right)$		$V_{th}(\mathrm{TNOM})~(V)$ or vth0 @ T=TNOM	kt1 (V)	$kt1l\ (V\cdot m)$	kt2	$NDEP~({ m cm}^{-3})$	$k1\ (V^{0.5})$	k2
218	0.289	0.371	-0.11	0	0.022	2.39e18	0.58	0.01
300	0.371	0.371	-0.11	0	0.022	1.5e18	0.459	0.01
398	0.46	0.371	-0.11	0	0.022	9.2e17	0.36	0.01

In [2]: from scipy.constants import k,e

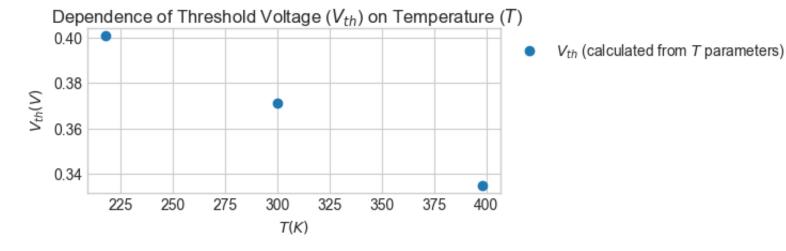
TNOM, PHIN, Leff, VBS = 300, 0, 49, 0 # Nano-CMOS compact model presets, as collated in eq (9) kB, q = k, e # natural constants kt1, kt11, kt2, k2 = -0.11, 0, 0.022, 0.01 # Nano-CMOS compact model constant parameter extracts

```
In [3]:
         class VThreshold:
             def __init__(self, vth0:float, k1:float, T:float, NDEP:float):
                 self.vth0 = vth0
                 self.kt1 = kt1
                 self.kt1l = kt1l
                 self.kt2 = kt2
                 self.Leff = Leff
                 self.TNOM = TNOM
                 self.T = T
                 self.PHIN = PHIN
                 self.VBS = VBS
                 self.NDEP = NDEP
                 self.k1 = k1
                 self.k2 = k2
                 self.kB = kB
                 self.q = q
             def Eq(self) -> float:
                 # calculates Energy-band gap of Silicon according to eq (6)
                 x = 1.16 - (7.02*1e-4*self.T**2)/(self.T+1108)
                 return x
             def ni(self) -> float:
                 # calculates intrinsic carrier concentration according to eq (5)
                 x = 1.45e10*((self.T/300.15)**1.5)**math.exp(21.5565981-((self.q*VThreshold.Eq(self)))/(2*self.kB*self.T)))
                 return x
             def PhiS(self) -> float:
                 # calculates surface potential along the channel according to eq (4)
                 x = 0.4 + ((self.kB*self.T)/self.q)*math.log(self.NDEP/VThreshold.ni(self)) + self.PHIN
                 return x
             def VBC(self) -> float:
                 # calculates VBC according to eq (3)
                 x = 0.9*(VThreshold.PhiS(self) - ((self.k1**2)/(4*self.k2**2)))
                 return x
             def VBSEFF(self) -> float:
                 # calculates VBSEFF according to eq (2)
                 x = VThreshold.VBC(self) + 0.5*((self.VBS-VThreshold.VBC(self)-0.001)+(math.sqrt((self.VBS-VThreshold.VBC(self)-0.001)**2-(4*0.001*VThreshold.VBC(self)))))
                 return x
             def VTH(self) -> float:
                 # calculates VTH as a function of T according to eq (1)
                 x = self.vth0 + (self.kt1+(self.kt11/self.Leff)+(self.kt2*VThreshold.VBSEFF(self)))*((self.T/self.TNOM)-1)
                 return x
```

```
In [4]: print(f"Calculated V_T values (218K,300K,398K): {VThreshold(T=218, vth0=0.371, NDEP=2.39e18, k1=0.58).VTH()}, {VThreshold(T=300, vth0=0.371, NDEP=1.5e18, k1=0.459).VTH()} {VThreshold(T=398, vth0=0.371, NDEP=9.2e17, k1=0.36).VTH()}")
```

Calculated V_T values (218K,300K,398K): 0.401066666666667, 0.371,0.3350666666666707

Out[5]: Text(0, 0.5, '\$V_{th} (V)\$')



Summary

1. The $V_{th}(T)$ shifts for 130nm NMOS calculated from the T parameter extracts using Eq. (3) - Eq. (9) and as plotted above, are in line with a decreasing V_T with increasing T as can be seen in the simulated Output IV and Transfer IV curves of Part I and Part II.

Calculation of T Parameters for μ (all units appropriated from 'Nano-CMOS' compact model, TEMPMOD/MOBMOD=0)

$$U0(T) = U0(\text{TNOM}) \cdot \left(\frac{T}{\text{TNOM}}\right)^{\text{UTE}}$$
 (10)

$$UA(T) = UA(\text{TNOM}) + UA1 \cdot \left(\frac{T}{\text{TNOM}} - 1\right)$$
(11)

$$UB(T) = UB(\text{TNOM}) + UB1 \cdot \left(\frac{T}{\text{TNOM}} - 1\right)$$
 (12)

$$UC(T) = UC(\text{TNOM}) + UC1 \cdot \left(\frac{T}{\text{TNOM}} - 1\right)$$
 (13)

(Eqs. (10) - (13) as noted in page 106 of [2] BSIM 4.8.2 Technical Manual)

Table summarising T parameter extracts from Nano-CMOS compact model relating to μ

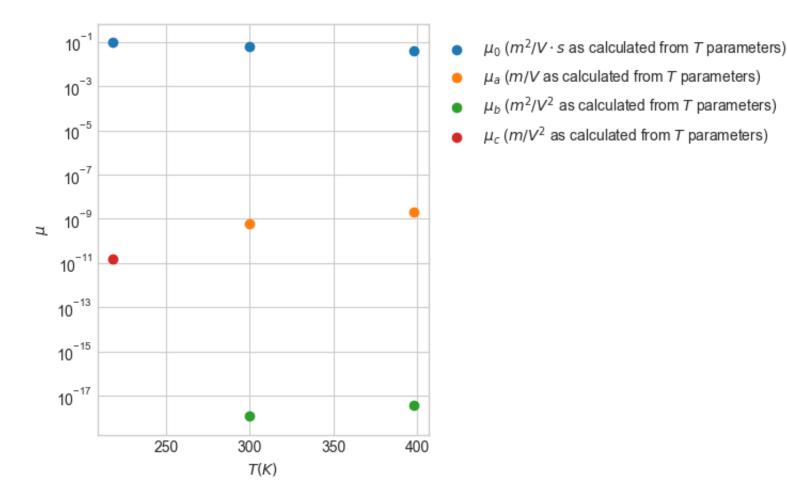
```
u0(TNOM) (m^2/V \cdot s)
                                               ute \ ua\ (m/V) \ ua1\ (m/V) \ ub\ (m^2/V^2) \ ub1\ (m^2/V^2) \ uc\ (m/V^2) \ uc1\ (m/V^2)
T(K) u0(m^2/V \cdot s)
                        or u0 @ T = TNOM
 218
          0.05036
                              0.05979
                                               -1.5
                                                       6e-10
                                                                   4.31e-9
                                                                                1.2e-18
                                                                                              7.61e-18
                                                                                                                         -5.6e-11
 300
          0.05979
                              0.05979
                                                                   4.31e-9
                                                                                                                         -5.6e-11
                                               -1.5
                                                       6e-10
                                                                                1.2e-18
                                                                                              7.61e-18
                                                                                                              0
 398
           0.0689
                              0.05979
                                               -1.5
                                                       6e-10
                                                                   4.31e-9
                                                                                1.2e-18
                                                                                              7.61e-18
                                                                                                                         -5.6e-11
```

```
In [6]:
         ute, ua, ual, ub, ubl, uc, ucl, TNOM = -1.5, 6e-10, 4.31e-9, 1.2e-18, 7.61e-18, 0, -5.6e-11, 300 # Nano-CMOS compact model constant parameter extracts
In [7]:
         class mu:
             def __init__(self, u0:float, T:float):
                 self.u0 = u0
                 self.ute = ute
                 self.ua = ua
                 self.ua1 = ua1
                 self.ub = ub
                 self.ub1 = ub1
                 self.uc = uc
                 self.uc1 = uc1
                 self.TNOM = TNOM
                 self.T = T
             def mu0(self) -> float:
                 # calculates Low-field mobility according to eq (8)
                 x = self.u0*((self.T/self.TNOM)**self.ute)
                 return x
             def mua(self) -> float:
                 # calculates `Coefficient of first-order mobility degradation due to vertical field' according to eq (9)
                 x = self.ua + ual*((self.T/self.TNOM)-1)
                 return x
             def mub(self) -> float:
                 # calculates `Coefficient of secon-order mobility degradation due to vertical field' according to eq (10)
                 x = self.ub + ub1*((self.T/self.TNOM)-1)
                 return x
             def muc(self) -> float:
                 # calculates `Coefficient of mobility degradation due to body-bias effect' according to eq (11)
                 x = self.uc + uc1*((self.T/self.TNOM)-1)
                 return x
```

```
print(f"Calculated u0 values (218K,300K,398K): {mu(T=218, u0=0.05979).mu0()}, {mu(T=300, u0=0.05979).mu0()}, {mu(T=398, u0=0.05979).mu0()}")
         print(f"Calculated ua values (218K,300K,398K): {mu(T=218, u0=0.05979).mua()}, {mu(T=300, u0=0.05979).mua()}, {mu(T=398, u0=0.05979).mua()}")
         print(f"Calculated ub values (218K,300K,398K): {mu(T=218, u0=0.05979).mub()}, {mu(T=300, u0=0.05979).mub()}, {mu(T=398, u0=0.05979).mub()}")
         print(f"Calculated uc values (218K,300K,398K): {mu(T=218, u0=0.05979).muc()}, {mu(T=300, u0=0.05979).muc()}, {mu(T=398, u0=0.05979).muc()}")
         #Note that ua/ub/uc~0
        Calculated u0 values (218K,300K,398K): 0.09652186284786184,0.05979,0.039127835808042494
        Calculated ua values (218K,300K,398K): -5.780666666666668e-10,6e-10,2.0079333333333334e-09
        Calculated ub values (218K,300K,398K): -8.800666666666667e-19,1.2e-18,3.685933333333333-18
        Calculated uc values (218K,300K,398K): 1.530666666666665e-11,0.0,-1.8293333333333334e-11
In [9]:
         fig,axes = plt.subplots(figsize=(4,5))
         fig.suptitle('Dependence of Mobility ($\mu 0$, $\mu a$, $\mu b$, $\mu c$) on Temperature ($T$)')
         plt.scatter([218,300,398],[mu(T=218, u0=0.05979).mu0(), mu(T=300, u0=0.05979).mu0(), mu(T=398, u0=0.05979).mu0()],label='$\mu 0$ ($\m^2/V\cdot s$ as calculated from $T$ pa
         plt.scatter([218,300,398],[mu(T=218, u0=0.05979).mua(), mu(T=300, u0=0.05979).mua(), mu(T=398, u0=0.05979).mua()],label='$\mu a$ ($\m/V$ as calculated from $T$ parameters)
         plt.scatter([218,300,398],[mu(T=218, u0=0.05979).mub(), mu(T=300, u0=0.05979).mub(), mu(T=398, u0=0.05979).mub()],label='$\mu b$ ($\m^2/V^2$ as calculated from $T$ paramet
         plt.scatter([218,300,398],[mu(T=218, u0=0.05979).muc(), mu(T=300, u0=0.05979).muc(), mu(T=398, u0=0.05979).muc()],label='$\mu c$ ($\mu/V^2$ as calculated from $T$ parameter
         plt.yscale('log')
         axes.legend(bbox_to_anchor=(1, 1), loc="upper left")
         axes.set xlabel('$T (K)$')
         axes.set ylabel('$\mu$')
```

Dependence of Mobility (μ 0, μ a, μ b, μ c) on Temperature (T)

Out[9]: Text(0, 0.5, '\$\\mu\$')



Summary

- 1. Mobility (μ_0) decreases with increasing T while mobility coefficients (μ_a, μ_b, μ_c) increase with T. This is due to an incresing scattering of charge carriers with increasing T inside the MOS channel lattice.
- 2. This effect cannot be seen qualitatively in the plots of Part I and Part II, which is due to other competing effects like channel length modulation and lowering V_T with increasing T.

Part IV: 45nm NMOS corner simulations

Table summarising Process Variability-Sensitive Global Device Parameter extracts from Nano-CMOS compact model relating to corner simulations

(parameters as noted in Table 8.2 of [1])

Corner Modeling	$vth0\ (V)$	xl(m)	$toxe/toxm\ (m)$	$u0~(m^2/V\cdot s)$	$k1\ (V^{1/2})$	$rdsw~(\Omega(\mu m)^{WR})$	$cgsl/cgdl\ (F/m)$	$cgso/cgdo\left(F/m ight)$	$cjs/cjd~(F/m^2)$	$cjsws/cjswd\ (F \ /m)$	$cjswgs/cjswgd\ (F \ /m)$
Nominal	0.41	-2e-8	1.75-9	0.04805	0.477	150	2.653e-10	1.1e-10	0.0005	5e-10	3e-10/5e-10
Fast-Fast	0.379	-2e-8	1.75-9	0.05045	0.45	150	2.653e-10	1.1e-10	0.0005	5e-10	3e-10/5e-10
Slow- Slow	0.439	-2e-8	1.75-9	0.04588	0.502	150	2.653e-10	1.1e-10	0.0005	5e-10	3e-10/5e-10

Summary

1. Since the only varying parameters in the table above are vth0, u0 and k1; key Nano-CMOS compact model parameters for the Nominal, Fast-Fast and Slow-Slow corners are: vth0, u0 and k1.

References

- [1] Compact Models For Integrated Circuit Design Samar K. Saha
- [2] BSIM 4.8.2 Technical Manual
- [3] BSIM 4.3.0 Technical Manual

Additional information

Created by: Rochish Manda, MSc KTH

IH2653 Examiner: Dr. Gunnar Malm, Professor KTH

Data and config files at: Github

http://localhost:8888/nbconvert/html/HW1.ipynb?download=false

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